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RESPONSE UNDER 37 CFR 1.116  
EXPEDITED PROCEDURE  
EXAMINING GROUP 2814PATENT APPLICATION  
Docket No.: 9903-074  
Client Ref. No.: S03US003

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Dong-Ho LEE

Serial No.: 10/750,979

Examiner: Le, Thao X.

Filed: January 2, 2004

Group Art Unit: 2814

Confirmation No.: 5476

For: STACK PACKAGE MADE OF CHIP SCALE PACKAGES

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450AMENDMENT AFTER FINAL REJECTION UNDER 37 CFR 1.116

Responsive to the Final Office Action, Paper No. 091605, dated September 22, 2005,  
please amend the application as follows.

Amendments to the Claims are reflected in the listing of claims which begins on  
page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.

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